

SPECIFICATION

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SPEC. NO.: PS-51023-XXXXX-XXX REVISION: B

PRODUCT NAME: 0.4mm BOARD TO FPC CONN. SMT D/R S/T TYPE

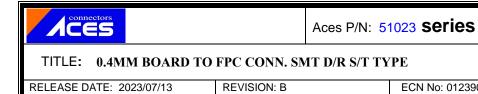
PRODUCT NO: 51023-XXXXX-XXX SERIES 51024-XXXXX-XXX SERIES

PREPARED: CHECKED: APPROVED:

TSO I CHIAO Chen, Chun Yuan Huang Kuo Hua

DATE: DATE:

2023/07/13 2023/07/13 2023/07/13



REVISION: B

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ECN No: 012390

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1 Revision History

Rev.	ECN#	Revision Description	Prepared	Date
1	1204097	FOR PDR APD1010070 NEW REV	ALEX	2012/04/30
0	1401217	RELEASE	CARL	2013/12/31
A	1802162	Durability Increase to 50 cycles	TSO I CHIAO	2018/02/23
В	012390	Add Salt Spray 48 hours	TSO I CHIAO	2023/07/13



TITLE: 0.4MM BOARD TO FPC CONN. SMT D/R S/T TYPE

2 SCOPE

This specification covers performance, tests and quality requirements for 0.4mm BOARD TO FPC CONN. SMT D/R S/T TYPE

3 APPLICABLE DOCUMENTS

EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

- 4.1 Design and Construction
 - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
 - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
 - 4.2.1 Contact: High performance copper alloy (Phosphor Bronze)

Finish: (a) Contact Area: Refer to the drawing.

- (b) Under plate: Refer to the drawing.
- (c) Solder area: Refer to the drawing.
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.3 Fitting Nail: Copper Alloy, Finish: Refer to the drawing.
- 4.3 Ratings
 - 4.3.1 Working Voltage Less than 36 Volts (per pin)
 - 4.3.2 Voltage: 60 Volts AC/DC (per pin)
 - 4.3.3 Current: 0.3 Amperes (per pin)

All pins can carry 5A Max.

4.3.4 Operating Temperature : -55°C to +85°C



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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard				
	Product shall meet requirements of	Visual, dimensional and functional				
Examination of Product	applicable product drawing and	per applicable quality inspection				
	specification.	plan.				
	ELECTRICAL					
Item	Requirement	Standard				
	-	Mate connectors, measure by dry				
Low Level	70 m Ω Max.(initial)per contact	circuit, 20mV Max., 100mA				
Contact Resistance	90 m Ω Max.(finish)	Max.				
		(EIA-364-23)				
		Unmated connectors, apply				
Insulation Resistance	1000 M Ω Min.	250 V DC between adjacent				
modiation resistance	1000 101 22 101111.	terminals.				
		(EIA-364-21)				
		150 VAC Min. at sea level for 1				
Dielectric	No discharge, flashover or	minute.				
Withstanding Voltage	breakdown.	Test between adjacent contacts of				
vviiiotarianig voltage	Current leakage: 1 mA max.	unmated connectors.				
		(EIA-364-20)				
		Mate connector: measure the				
		temperature rise at rated current				
Temperature rise	30°C Max. Change allowed	until temperature stable. The				
		ambient condition is still air at 25°C				
		(EIA-364-70,METHOD1,CONDITION1)				
	MECHANICAL					
Item	Requirement	Standard				
		The sample should be mounted in				
		the tester and fully mated and				
Durability	50 cycles.	unmated the number of cycles				
Darability	System.	specified at the rate of				
		25.4 ± 3 mm/min.				
		(EIA-364-09)				
	Mating	(EIA-364-09) Operation Speed :				
	Mating	(EIA-364-09) Operation Speed: 25.4 ± 3 mm/minute				
Mating/Unmating Forces	0.981N (Max.) /Per Pin	(EIA-364-09) Operation Speed :				
Mating/Unmating Forces	0.981N (Max.) /Per Pin Unmating	(EIA-364-09) Operation Speed: 25.4 ± 3 mm/minute Measure the force required to mate/unmate connector.				
Mating/Unmating Forces	0.981N (Max.) /Per Pin	(EIA-364-09) Operation Speed: 25.4 ± 3 mm/minute Measure the force required to mate/unmate connector. (EIA-364-13)				
Mating/Unmating Forces	0.981N (Max.) /Per Pin Unmating	(EIA-364-09) Operation Speed: 25.4 ± 3 mm/minute Measure the force required to mate/unmate connector. (EIA-364-13) Apply axial pull out force at the				
Terminal / Housing	0.981N (Max.) /Per Pin Unmating 0.165N(Min.)/Per Pin	(EIA-364-09) Operation Speed: 25.4 ± 3 mm/minute Measure the force required to mate/unmate connector. (EIA-364-13) Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute.				
Terminal / Housing Retention Force	0.981N (Max.) /Per Pin Unmating	(EIA-364-09) Operation Speed: 25.4 ± 3 mm/minute Measure the force required to mate/unmate connector. (EIA-364-13) Apply axial pull out force at the				
	0.981N (Max.) /Per Pin Unmating 0.165N(Min.)/Per Pin	(EIA-364-09) Operation Speed: 25.4 ± 3 mm/minute Measure the force required to mate/unmate connector. (EIA-364-13) Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute.				
Terminal / Housing Retention Force	0.981N (Max.) /Per Pin Unmating 0.165N(Min.)/Per Pin	(EIA-364-09) Operation Speed: 25.4 ± 3 mm/minute Measure the force required to mate/unmate connector. (EIA-364-13) Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the				
Terminal / Housing Retention Force (Rcpt. CONN.)	0.981N (Max.) /Per Pin Unmating 0.165N(Min.)/Per Pin	(EIA-364-09) Operation Speed: 25.4 ± 3 mm/minute Measure the force required to mate/unmate connector. (EIA-364-13) Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing. Operation Speed:				
Terminal / Housing Retention Force	0.981N (Max.) /Per Pin Unmating 0.165N(Min.)/Per Pin 0.05kgf MIN.	(EIA-364-09) Operation Speed: 25.4 ± 3 mm/minute Measure the force required to mate/unmate connector. (EIA-364-13) Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing. Operation Speed: 25.4 ± 3 mm/minute.				
Terminal / Housing Retention Force (Rcpt. CONN.) Fitting Nail /Housing	0.981N (Max.) /Per Pin Unmating 0.165N(Min.)/Per Pin	(EIA-364-09) Operation Speed: 25.4 ± 3 mm/minute Measure the force required to mate/unmate connector. (EIA-364-13) Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing. Operation Speed:				



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		The electrical load condition shall
		be 100 mA maximum for all
		contacts. Subject to a simple
		harmonic motion having amplitude
		of 0.76mm (1.52mm maximum
		total excursion) in frequency
Vibration	1 us May	between the limits of 10 and 55 Hz.
Vibration	1 μs Max.	The entire frequency range, from
		10 to 55 Hz and return to 10 Hz,
		shall be traversed in approximately
		1 minute. This motion shall be
		applied for 2 hours in each of three
		mutually perpendicular directions.
		(EIA-364-28 Condition I)
		Subject mated connectors to
		50 G's (peak value) half-sine shock
		pulses of 11 milliseconds duration.
		Three shocks in each direction
Shock (Mechanical)	1 us May	shall be applied along the three
Shock (Wechanical)	1 μs Max.	mutually perpendicular axes of the
		test specimen (18 shocks). The
		electrical load condition shall be
		100mA maximum for all contacts.
		(EIA-364-27, test condition A)

ENVIRONMENTAL						
Item	Requirement	Standard				
Resistance to Reflow Soldering Heat	See Product Qualification and Test (Lead Free)	Pre Heat: 150°C~180°C, 60~120sec. Heat: 230°C Min., 40sec Min. Peak Temp.: 260°C Max, 10sec Max.				
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition I)				
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH, 120 hours. (EIA-364-31,Condition A, Method II)				
Temperature life	See Product Qualification and Test Sequence Group 5	Subject mated connectors to temperature life at 85°C for 96 hours. (EIA-364-17, Test condition A)				



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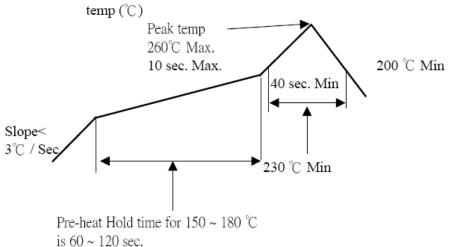
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating 3 u" or more for 48 hours. (III) Gold plating 5 u" or more for 96 hours. (EIA-364-26)
Solder ability	minimum of 95% solder coverage.	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)
Hand Soldering Temperature Resistance	Appearance: No damage	T≧350°C, 3sec at least.

Note. Flowing Mixed Gas shell be conduct by customer request.

6 INFRARED REFLOW CONDITION

6.1. Lead-Free Process

TEMPERATURE CONDITION GRAPH (TEMPERATURE ON BOARD PATTERN SIDE)





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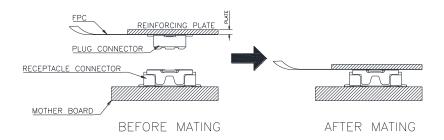
7 PRODUCT QUALIFICATION AND TEST SEQUENCE

		Test Group									
Test or Examination	1	2	3	4	5	6	7	8	9		
		Test Sequence									
Examination of Product	1,3	1	1	1 . 7	1、6	1 \ 4			1,3		
Low Level Contact Resistance		2、6	2 ` 5	2、8	2 · 7	2 ` 5					
Insulation Resistance				3、9	3、8						
Dielectric Withstanding Voltage				4 \ 10	4 \ 9						
Temperature rise	2										
Mating / Unmating Forces		3 \ 5									
Durability		4									
Vibration			3								
Shock (Mechanical)			4								
Thermal Shock				5							
Humidity				6							
Temperature life					5						
Salt Spray(Only For Gold Plating)						3					
Solder ability							1				
Terminal / Housing Retention Force (Rcpt. CONN.)								1			
Fitting Nail /Housing Retention Force (PLUG/Rcpt. CONN.)								2			
Hand Soldering Temperature Resistance									2		
Sample Size	2	4	4	4	4	4	2	4	4		



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8. CONNECTOR USAGE



MATING PROCEDURE

- 1. Set the FPC block's position roughly.
- 2. Check the position of FPC block, moving it slightly.
- 3. Mate the connector until it becomes flat.(Don't push by too much force)
- 4. Check the mating state by pushing every corner of connector to prevent from

Miss mating.

Check the mating condition



UNMATING PROCEDURE

